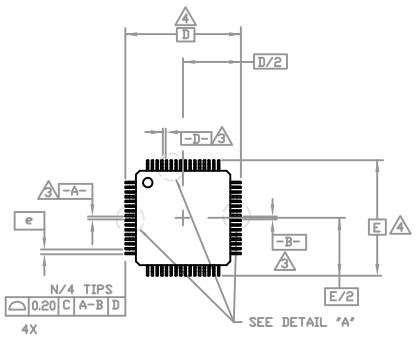
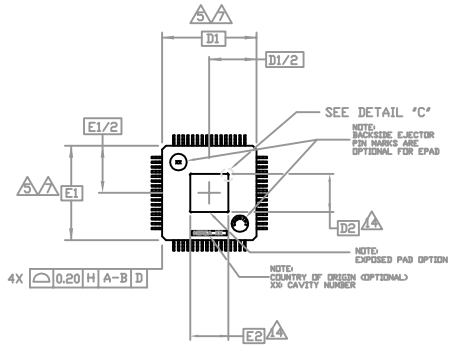
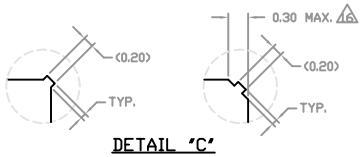
REVISION HISTORY				
REV	DESCRIPTION	DATE	CHANGED	RELEASED
00	INITIAL RELEASE PER DCN #A34737.	02/27 1992	YMK	XXX
01	INCORPORATED PER DCN #D20036.	07/14 1992	YMK	XXX
02	INCORPORATED PER DCN #A35401.	08/28 1992	YMK	XXX
03	INCORPORATED PER DCN #A35774.	01/15 1993	YMK	XXX
04	INCORPORATED PER DCN #D20883.	09/14 1993	YMK	XXX
05	REVISED PER DCN #D21714. (ENG-AE-937 BECOMES 32770/05)	09/08 1994	YMK	XXX
06	REVISED PER DCN #D24551.	09/26 1998	MP	XXX
07	INCORPORATED PER DCN #D28531	01/05 2001	AAYRE	AAYRE

TOP VIEW



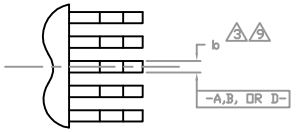
BOTTOM VIEW



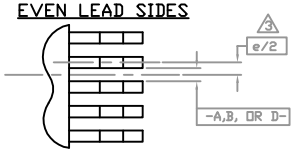


DETAIL "C"
(EXPOSED PAD CORNER DETAIL)

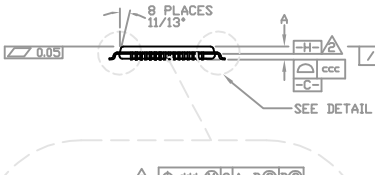
ODD LEAD SIDES

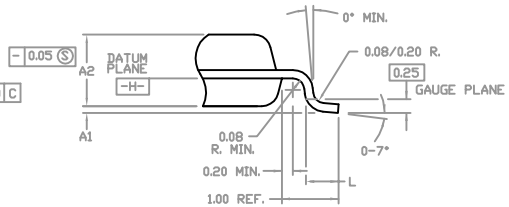


EVEN LEAD SIDES

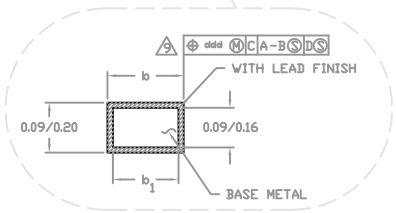


DETAIL "A"





DETAIL "B"



XXXX	XXXX	XXXX	XXXX
DESCRIPTION	MATERIAL	PLATE	SID NUMBER

UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN MILLIMETERS
DECIMAL: X.X ±0.1 mm; X.XX ±0.05 mm; X.XXX ±0.025 mm
ANGULAR ±1°
INTERPRET DIM AND TOL PER ASME Y14.5M – 1994
THIRD ANGLE PROJECTION
PRINTING IS SCALED TO FIT DO NOT SCALE DRAWING

Amkor Technology, Inc. Chandler, Arizona, USA
Anam Semiconductor, Inc., Seoul, Korea
Amkor Technology Philippines, Inc. Manila, Philippines

APPROVALS		DATE
DRAWN	J DAVIS	02/27 1992
CHECKED	JM BIRD	02/27 1992
APPROVED	J DAVIS	02/27 1992
RELEASED	YK KANG	02/27 1992

TITLE: PACKAGE OUTLINE, MATRIX, TQFP, 7 X 7 mm BODY, 1.00/0.10 mm FORM, 1.00 mm THICK (OPTIONAL ePAD)

SIZE	DWG NUMBER	REV
A3	32770	07

SCALE	CHARGER CODE	SHEET
6:1	XXXX	1 OF 2

FORM NO. MDFORM3J.DWG